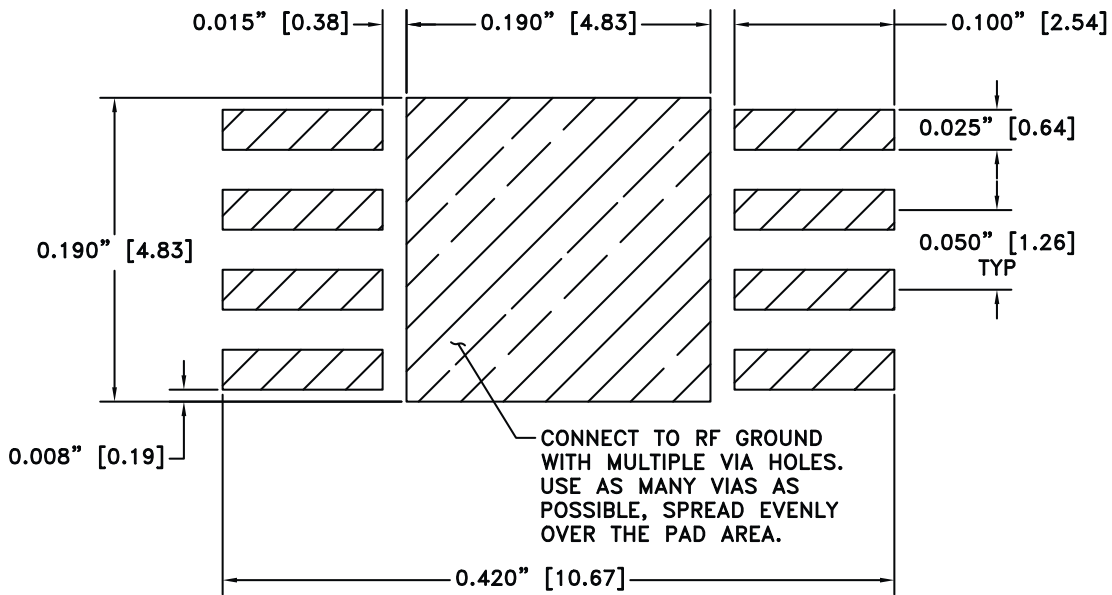


**G8 – 8 LEAD GLASS/METAL  
 HERMETIC SMT PACKAGE**

**Suggested G8 PCB Land Pattern**



**NOTES:**

1. DIMENSIONS ARE IN INCHES [MILLIMETERS].
2. PAD WIDTH SHOWN IS FOR SOLDERING ONLY. BEYOND SOLDERING AREA ALL CONDUCTORS THAT CARRY RF AND MICROWAVE SIGNALS SHOULD HAVE 50 OHM CHARACTERISTIC IMPEDANCE.